

Weidmüller Interface GmbH & Co. KG Klingenbergstraße 26 D-32758 Detmold

www.weidmueller.com

Germany

Product image





High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 5.00 mm, Number of poles: 11, 180°, Solder pin length (I): 3.2 mm, tinned, black, Box
Order No.	<u>1841250000</u>
Туре	SL-SMT 5.00HC/11/180G 3.2SN BK BX
GTIN (EAN)	4032248352159
Qty.	50 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Box

Creation date March 25, 2021 5:30:26 PM CET

Catalogue status 12.03.2021 / We reserve the right to make technical changes.



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Technical data

Dimensions	and weight	ts
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Depth	8.5 mm	Depth (inches)	0.335 inch
Height	15.2 mm	Height (inches)	0.598 inch
Height of lowest version	12 mm	Net weight	5.02 g
Width	58.2 mm	Width (inches)	2.291 inch

System specifications

		T (
Product family	OMNIMATE Signal - series BL/SL 5.00	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	180°
Number of poles	11	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin length tolerance	+0.1 / -0.2 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0,03 mm
Solder eyelet hole diameter (D)	1.5 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm
L1 in mm	50 mm	L1 in inches	1.969 inch
Number of rows	1	Pin series quantity	1
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	7 N	Pulling force/pole, max.	5.5 N

Material data

Insulating material	LCP GF
Colour chart (similar)	RAL 9011
Comparative Tracking Index (CTI)	≥ 175
UL 94 flammability rating	V-0
Contact surface	
	tinned
Layer structure of plug contact	13 µm Ni / 24 µm Sn
	matt
Storage temperature, max.	70 °C
Operating temperature, max.	100 °C
Temperature range, installation, max.	100 °C

Colour	black
Insulating material group	Illa
Moisture Level (MSL)	1
Contact material	CuMg
Layer structure of solder connection	13 µm Ni / 24 µm Sn
	matt
Storage temperature, min.	
	-40 °C
Operating temperature, min.	-50 °C
Temperature range, installation, min.	-30 °C

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	27.5 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	19 A	(Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		

Technical data

SL-SMT 5.00HC/11/180G 3.2SN BK BX



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		0 (C) (00A)			
Institute (CSA)	SP	Certificate No. (CSA)			
			200039-1176845		
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V		
Rated current (Use group B / CSA)	15 A	Rated current (Use group D / CSA)	15 A		
Reference to approval values	Specifications are maximum values, details - see approval certificate.				
Rated data acc. to UL 1059					
Institute (UR)		Certificate No. (UR)			
	M		50000		
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	E60693 300 V		
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)			
Reference to approval values	Specifications are maximum values, details - see approval certificate.				
Packing					
Packaging	Вох	VPE length	35 mm		
VPE width	115 mm	VPE height	170 mm		
Classifications					
ETIM 6.0	EC002637	ETIM 7.0	EC002637		
ECLASS 9.0 ECLASS 10.0	27-44-04-02 27-44-04-02	ECLASS 9.1 ECLASS 11.0	27-44-04-02 27-46-02-01		
	27-44-04-02	ECLASS TT.U	27-46-02-01		
Important note					
IPC conformity	standards and norms and comp	eveloped, manufactured and delivered according ly with the assured properties in the data sheet r Class 2". Further claims on the products can be e	esp. fulfill decorative proper		
Notes	Gold-plated contact surfaces	on request			
	Rated current related to rated cross-section & min. No. of poles.				
	• Diameter of solder eyelet D =	Diameter of solder eyelet D = 1.4+0.1mm			
 Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles 					
	• P on drawing = pitch	g = pitch			
	-	omponent itself. Clearance and creepage distance	ces to other components are		
	be designed in accordance w	ith the relevant application standards.			

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Technical data

Approvals	
Approvals	
ROHS	Conform
UL File Number Search	E60693
Downloads	
Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	STEP

Drawings

Product image



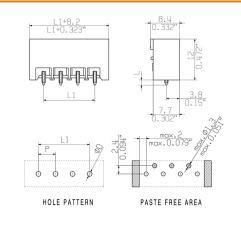


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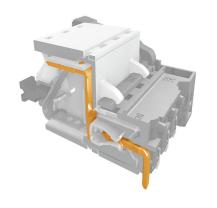
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Dimensional drawing



Product benefits



Safe power transmission Proven properties

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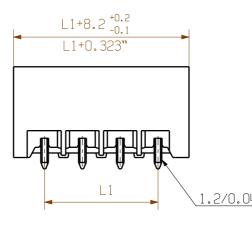
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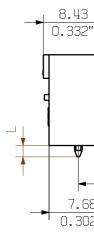
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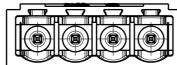
Drawings

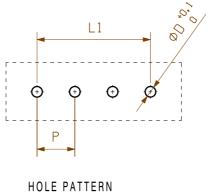
Product benefits

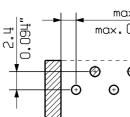












				The Englis	n version is binding
			.22 ^h .0 .8 15"	The English	n version is binding
	2.4 	 max.0.079 	O O O		24 115,00 4,528 23 110,00 4,331 22 105,00 4,134 21 100,00 3,937 20 95,00 3,740 19 90,00 3,543 18 85,00 3,346 17 80,00 3,150 16 75,00 2,953 15 70,00 2,756 14 65,00 2,559
					13 60,00 2,362 12 55,00 2,165
N		PASTE FREE A	AREA		12 55,00 2,165 11 50,00 1,969 10 45,00 1,772 9 40,00 1,575 8 35,00 1,378 7 30,00 1,181 6 25,00 0,984
D = 1.4/0.055" or 1.5/0.05 RECOMMENDATION F	9"(REFLOW SOLDERING)	IV	STIFTLAENGE L	TOLERANZ	5 20,00 0,787
(1.4mm FOR n=28	/ 1.5mm for n=924)		1,5	0,0 -0,3	4 15,00 0,591 3 10,00 0,394
P = RASTER/PITCH			3,2	0,1	2 5,00 0,197
SHOWN: SL-SMT 5.00HC/0	04/180 G		0,2	-0,3]n L1 [mm] L1 [inch] at.no.: .
DIN ISO 27	68-m Modification	Weid	lmüller a	C Drawing no	34165 07
F-1A	Date	Name			
	Drawn 22.01.2008	HERTEL_S	SL-SMT 5		./180
Scale: 2/1	Responsible Checked 27.08.2018	HERTEL_S HERTEL_S	S	TIFTLEISTE IN HEADER	
Supersedes: .	Approved		- duct file: SL-SMT 5.0		7279
		1.00		-	, 2, 0

For the mounting of PCBs, it should be noted that the rated data stated here relates only to the PCB components

alone. The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

Wave Solder Profile

Recommended wave solderding profiles

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Double Wave:

Single Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Reflow Solder Profile

Recommended reflow soldering profile



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Time [sec]

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.